Thermal Stability in Precision Cosmology Experiments: The Planck LFI Case

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Planck/LF



- Produce full sky CMB maps with an angular resolution, at 70 GHz, of about 13 arcmin and a sensitivity per pixel, of few μK.
- Cryogenically cooled low noise detectors
- Accurate control of systematic effects at μK level



Systematic effects

- Beam distortions
- Straylight
- Thermal effects
- Intrinsic instrumental effects
- Pointing



Systematic effects





Thermal environment



50 K telescope environment

V-grooves at different temperatures

300 K stage



Thermal environment

4 K HFI focal plane 0.1 K HFI bolometers

20 K LFI focal plane

LFI waveguides from 20 K to 300 K

L.Terenzi IASF/CNR LTD-10 Workshop

Requirements on max systematics from thermal effects

Repented @

Ud-10.90



 The global contribution from other periodic thermal fluctuations in each pixel will be less than ± 1.1 μK

Sensitivity of LFI radiometers to thermal fluctuations



Fluctuations propagation





Fluctuation sources: sorption





Single bed cycle: 667 sec Full cycle : 4000 sec





Fluctuations propagation

Sorption cooler



Front end

Thermo-mechanical damping Low pass filter





Fluctuations propagation





Values of T_f for $\partial G/\partial T_{phys} \sim 0.05$ dB/K and $\partial T_n/\partial T_{phys} \sim 0.8$ K/K

30 GHz	44 GHz	70 GHz
0.17	0.13	0.08

Data Analysis



Map Production



Destriping

Too high level: 5.3 to 8.1 µK in the maps !

Hardware solution: active T control



Mechanical constraint Low power (about 100mW) Limited thermal break



Hardware solution: active T







Hardware solution: active T con





Hardware solution: active T



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Frequency (GHz)	30	44	70
δT p-p (μK) Before destriping	11.1	10.4	14.6
δT p-p (μK) After destriping	0.65	0.65	1.00





Summary and Conclusions

- Relevant thermal effects identification
- Propagate effects to detectors
- Evaluation of the effects upon measurement
- Reduce the effects if needed